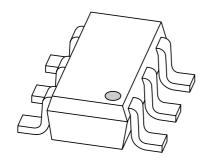
# DISCRETE SEMICONDUCTORS

# DATA SHEET



# PMEM4020PD PNP transistor/Schottky-diode module

Product data sheet 2003 Nov 24



# PNP transistor/Schottky-diode module

## PMEM4020PD

### **FEATURES**

- 600 mW total power dissipation
- · High current capability
- · Reduces required PCB area
- · Reduced pick and place costs
- Small plastic SMD package.

### **Transistor**

• Low collector-emitter saturation voltage.

### Diode

- · Ultra high-speed switching
- · Very low forward voltage
- · Guard ring protected.

### **APPLICATIONS**

- DC-to-DC converters
- · Inductive load drivers
- · General purpose load drivers
- Reverse polarity protection circuits.

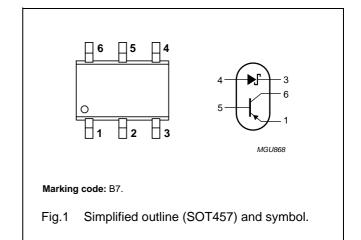
### **DESCRIPTION**

Combination of a PNP transistor with low  $V_{CEsat}$  and high current capability and a planar Schottky barrier diode with an integrated guard ring for stress protection in a SOT457 (SC-74) small plastic package.

NPN complement: PMEM4020ND.

### **PINNING**

| PIN | DESCRIPTION   |
|-----|---------------|
| 1   | emitter       |
| 2   | not connected |
| 3   | cathode       |
| 4   | anode         |
| 5   | base          |
| 6   | collector     |



### **ORDERING INFORMATION**

| TYPE NUMBER  |      | PACKAGE                                  |         |  |  |  |
|--------------|------|--|---------|--|--|--|
| TIFE NOWIDER | NAME | DESCRIPTION                              | VERSION |  |  |  |
| PMEM4020PD   | _    | plastic surface mounted package; 6 leads | SOT457  |  |  |  |

# PNP transistor/Schottky-diode module

PMEM4020PD

### **LIMITING VALUES**

In accordance with the Absolute Maximum System (IEC 60134).

| SYMBOL           | PARAMETER                           | CONDITIONS                             | MIN. | MAX.  | UNIT |
|------------------|-------------------------------------|--|------|-------|------|
| PNP transi       | stor                                |  | 1    | •     |      |
| V <sub>CBO</sub> | collector-base voltage              | open emitter                           | _    | -40   | V    |
| V <sub>CEO</sub> | collector-emitter voltage           | open base                              | _    | -40   | V    |
| V <sub>EBO</sub> | emitter-base voltage                | open collector                         | _    | -5    | V    |
| Ic               | collector current (DC)              | note 1                                 | _    | -0.75 | Α    |
|                  |                                     | note 2                                 | _    | -1    | Α    |
|                  |                                     | note 3                                 | _    | -1.3  | Α    |
|                  |                                     | T <sub>s</sub> ≤ 55 °C; note 4         | _    | -2    | Α    |
| I <sub>CM</sub>  | peak collector current              |  | _    | -3    | Α    |
| I <sub>BM</sub>  | peak base current                   |  | _    | -1    | Α    |
| P <sub>tot</sub> | total power dissipation             | T <sub>amb</sub> ≤ 25 °C; note 1       | _    | 295   | mW   |
|                  |                                     | T <sub>amb</sub> ≤ 25 °C; note 2       | _    | 400   | mW   |
|                  |                                     | T <sub>amb</sub> ≤ 25 °C; note 3       | _    | 500   | mW   |
|                  |                                     | T <sub>s</sub> ≤ 55 °C; note 4         | _    | 1000  | mW   |
| Tj               | junction temperature                |  | _    | 150   | °C   |
| Schottky b       | arrier diode                        |  |      |       |      |
| $V_R$            | continuous reverse voltage          |  | _    | 20    | V    |
| l <sub>F</sub>   | continuous forward current          |  | _    | 1     | А    |
| I <sub>FSM</sub> | non-repetitive peak forward current | t = 8.3 ms half sinewave; JEDEC method | _    | 5     | А    |
| P <sub>tot</sub> | total power dissipation             | T <sub>amb</sub> ≤ 25 °C; note 1       | _    | 295   | mW   |
|                  |                                     | T <sub>amb</sub> ≤ 25 °C; note 2       | _    | 400   | mW   |
|                  |                                     | T <sub>amb</sub> ≤ 25 °C; note 3       | _    | 500   | mW   |
|                  |                                     | T <sub>s</sub> ≤ 55 °C; note 4         | _    | 1000  | mW   |
| T <sub>j</sub>   | junction temperature                | note 2                                 | _    | 150   | °C   |
| Combined         | device                              |  |      |       |      |
| P <sub>tot</sub> | total power dissipation             | T <sub>amb</sub> = 25 °C; note 2       | _    | 600   | mW   |
| T <sub>stg</sub> | storage temperature                 |  | -65  | +150  | °C   |
| T <sub>amb</sub> | operating ambient temperature       | note 2                                 | -65  | +150  | °C   |
|                  | •                                   | •                                      |      |       | •    |

### **Notes**

- 1. Device mounted on a FR4 printed-circuit board; single-sided copper; tinplated; standard footprint for SOT457.
- 2. Device mounted on a FR4 printed-circuit board; single-sided copper; tinplated; mounting pads for collector and cathode both 1 cm<sup>2</sup>.
- 3. Mounted on a ceramic printed-circuit board; single-sided copper; tinplated; standard footprint.
- 4. Solder point of collector or cathode tab.

# PNP transistor/Schottky-diode module

### PMEM4020PD

### THERMAL CHARACTERISTICS

| SYMBOL               | PARAMETER  | CONDITIONS                 | VALUE | UNIT |  |  |
|----------------------|--|----------------------------|-------|------|--|--|
| Single devic         |  |                            |       |      |  |  |
| R <sub>th(j-s)</sub> | thermal resistance from junction to solder point | in free air; notes 1 and 2 | 95    | K/W  |  |  |
| ()/                  | thermal resistance from junction to              | in free air; notes 1 and 3 | 250   | K/W  |  |  |
|                      | ambient  | in free air; notes 1 and 4 | 315   | K/W  |  |  |
|                      |  | in free air; notes 1 and 5 | 425   | K/W  |  |  |
| Combined device      |  |                            |       |      |  |  |
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient      | in free air; notes 1 and 3 | 208   | K/W  |  |  |

### **Notes**

- 1. For Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses. Nomograms for determination of the reverse power losses  $P_R$  and  $I_F$  (AV) rating will be available on request.
- 2. Solder point of collector or cathode tab.
- 3. Device mounted on a ceramic printed-circuit board; single-sided copper; tinplated; standard footprint.
- 4. Device mounted on a FR4 printed-circuit board; single-sided copper; tinplated; mounting pad for collector and cathode both 1 cm<sup>2</sup>.
- 5. Device mounted on a FR4 printed-circuit board, single-sided copper; tinplated; standard footprint for SOT457.

2003 Nov 24

# PNP transistor/Schottky-diode module

# PMEM4020PD

### **ELECTRICAL CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

| SYMBOL  | PARAMETER                            | MIN.   | TYP. | MAX. | UNIT |           |
|---|--------------------------------------|--|------|------|------|-----------|
| PNP transis                                     | stor                                 |  |      |      |      | •         |
| I <sub>CBO</sub> collector-base cut-off current |                                      | $V_{CB} = -40 \text{ V}; I_{E} = 0$                                  | _    | _    | -100 | nA        |
|   |                                      | $V_{CB} = -40 \text{ V}; I_E = 0; T_{amb} = 150 ^{\circ}\text{C}$    | _    | _    | -50  | μΑ        |
| I <sub>CEO</sub>                                | collector-emitter cut-off current    | $V_{CE} = -30 \text{ V}; I_B = 0$                                    | _    | _    | -100 | nA        |
| I <sub>EBO</sub>                                | emitter-base cut-off current         | $V_{EB} = -5 \text{ V}; I_C = 0$                                     | _    | _    | -100 | nA        |
| h <sub>FE</sub>                                 | current gain (DC)                    | $V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ mA}$                       | 300  | -    | _    |           |
|   |                                      | $V_{CE} = -5 \text{ V}; I_{C} = -100 \text{ mA}$                     | 300  | _    | 800  |           |
|   |                                      | $V_{CE} = -5 \text{ V}; I_{C} = -500 \text{ mA}$                     | 250  | _    | _    |           |
|   |                                      | $V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ A}$                        | 160  | _    | _    |           |
|   |                                      | $V_{CE} = -5 \text{ V}; I_{C} = -2 \text{ A}; \text{ note 1}$        | 50   | _    | _    |           |
| V <sub>CEsat</sub>                              | collector-emitter saturation voltage | $I_C = -100 \text{ mA}; I_B = -1 \text{ mA}$                         | _    | _    | -120 | mV        |
|   |                                      | $I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$                        | _    | _    | -145 | mV        |
|   |                                      | $I_C = -1 \text{ A}; I_B = -100 \text{ mA}$                          | _    | _    | -260 | mV        |
|   |                                      | $I_C = -2 \text{ A}; I_B = -200 \text{ mA}$                          | _    | _    | -530 | mV        |
| $V_{BEsat}$                                     | base-emitter saturation voltage      | ase-emitter saturation voltage $I_C = -1 A$ ; $I_B = -50 \text{ mA}$ |      | _    | -1.1 | V         |
| R <sub>CEsat</sub>                              | equivalent on-resistance             | $I_C = -1 \text{ A}$ ; $I_B = -100 \text{ mA}$ ; note 1              | _    | 180  | 280  | $m\Omega$ |
| $V_{BEon}$                                      | base-emitter turn-on voltage         | $V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ A}$                        | _    | _    | -1   | V         |
| f <sub>T</sub>                                  | transition frequency                 | $I_C = -50 \text{ mA}; V_{CE} = -10 \text{ V};$<br>f = 100 MHz       | 150  | _    | _    | MHz       |
| Schottky b                                      | arrier diode                         |  |      |      |      | ,         |
| V <sub>F</sub>                                  | continuous forward voltage           | see Fig.2; note 1  |      |      |      |           |
|   |                                      | I <sub>F</sub> = 10 mA   | _    | 240  | 270  | mV        |
|   |                                      | I <sub>F</sub> = 100 mA  | _    | 300  | 350  | mV        |
|   |                                      | I <sub>F</sub> = 1000 mA   | _    | 480  | 550  | mV        |
| I <sub>R</sub>                                  | reverse current                      | see Fig.3; note 1  |      |      |      |           |
|   |                                      | V <sub>R</sub> = 5 V   | _    | 5    | 10   | μΑ        |
|   |                                      | V <sub>R</sub> = 8 V   | _    | 7    | 20   | μΑ        |
|   |                                      | V <sub>R</sub> = 15 V  | _    | 10   | 50   | μΑ        |
| C <sub>d</sub>                                  | diode capacitance                    | V <sub>R</sub> = 5 V; f = 1 MHz; see Fig.4                           | _    | 19   | 25   | pF        |

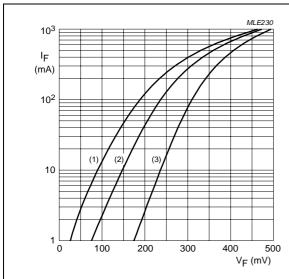
### Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

# PNP transistor/Schottky-diode module

### PMEM4020PD

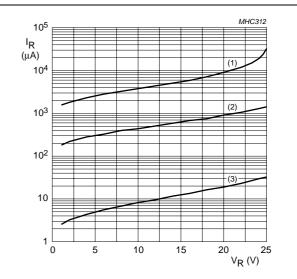
### **GRAPHICAL DATA**



### Schottky barrier diode.

- (1)  $T_{amb} = 125 \,^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .

Fig.2 Forward current as a function of forward voltage; typical values.



### Schottky barrier diode.

- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .

Fig.3 Reverse current as a function of reverse voltage; typical values.

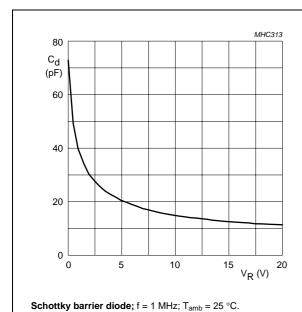
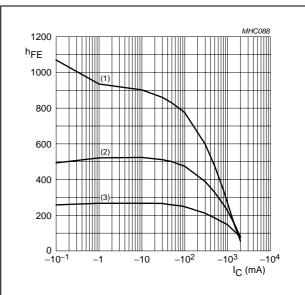


Fig.4 Diode capacitance as a function of reverse voltage; typical values.



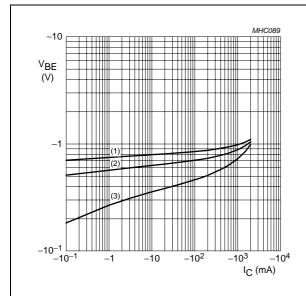
**PNP** transistor;  $V_{CE} = -5 \text{ V}$ .

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.5 DC current gain as a function of collector current; typical values.

# PNP transistor/Schottky-diode module

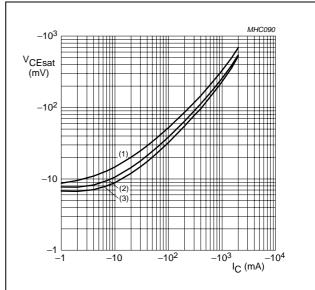
### PMEM4020PD



PNP transistor;  $V_{CE} = -5 \ V$ .

- (1)  $T_{amb} = -55 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

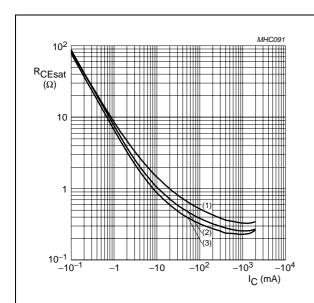
Fig.6 Base-emitter voltage as a function of collector current; typical values.



**PNP** transistor;  $I_C/I_B = 10$ .

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

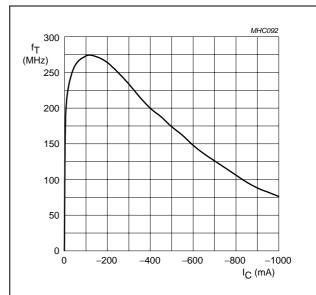
Fig.7 Collector-emitter saturation voltage as a function of collector current; typical values.



**PNP** transistor;  $I_C/I_B = 10$ .

- (1) T<sub>amb</sub> = 150 °C.
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.8 Equivalent on-resistance as a function of collector current; typical values.



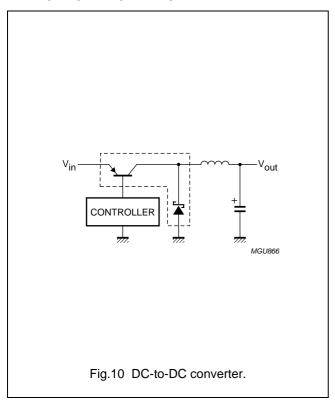
PNP transistor;  $V_{CE} = -10 \ V$ .

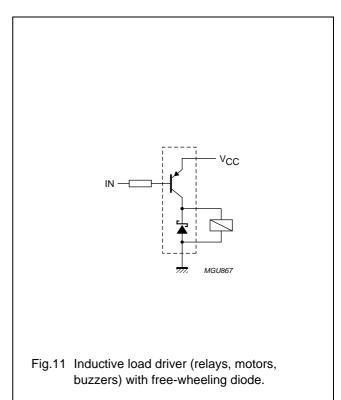
Fig.9 Transition frequency as a function of collector current.

# PNP transistor/Schottky-diode module

# PMEM4020PD

### **APPLICATION INFORMATION**





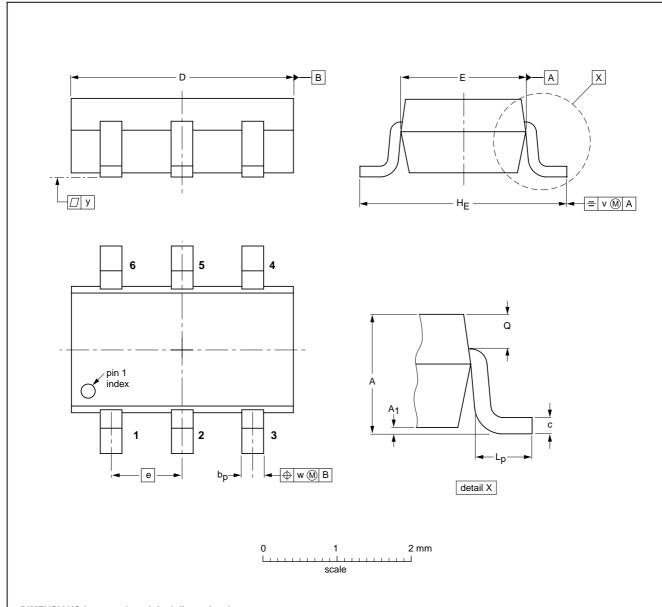
# PNP transistor/Schottky-diode module

# PMEM4020PD

### **PACKAGE OUTLINE**

### Plastic surface mounted package; 6 leads

SOT457



### DIMENSIONS (mm are the original dimensions)

| UNI | Г А        | A <sub>1</sub> | bp           | С            | D          | E          | е    | HE         | Lp         | Q            | v   | w   | у   |
|-----|------------|----------------|--------------|--------------|------------|------------|------|------------|------------|--------------|-----|-----|-----|
| mm  | 1.1<br>0.9 | 0.1<br>0.013   | 0.40<br>0.25 | 0.26<br>0.10 | 3.1<br>2.7 | 1.7<br>1.3 | 0.95 | 3.0<br>2.5 | 0.6<br>0.2 | 0.33<br>0.23 | 0.2 | 0.2 | 0.1 |

| OUTLINE |     | REFER | EUROPEAN ISSUE DATE |  |                            |                                 |
|---------|-----|-------|---------------------|--|----------------------------|---------------------------------|
| VERSION | IEC | JEDEC | EIAJ                |  | PROJECTION                 | ISSUE DATE                      |
| SOT457  |     |       | SC-74               |  | $ \  \   \bigoplus  \big($ | <del>97-02-28</del><br>01-05-04 |

# PNP transistor/Schottky-diode module

### PMEM4020PD

### **DATA SHEET STATUS**

| DOCUMENT<br>STATUS <sup>(1)</sup> | PRODUCT<br>STATUS <sup>(2)</sup> | DEFINITION  |
|-----------------------------------|----------------------------------|---|
| Objective data sheet              | Development                      | This document contains data from the objective specification for product development. |
| Preliminary data sheet            | Qualification                    | This document contains data from the preliminary specification.                       |
| Product data sheet                | Production                       | This document contains the product specification.                                     |

### **Notes**

- 1. Please consult the most recently issued document before initiating or completing a design.
- The product status of device(s) described in this document may have changed since this document was published
  and may differ in case of multiple devices. The latest product status information is available on the Internet at
  URL http://www.nxp.com.

### **DISCLAIMERS**

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings

System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

# **NXP Semiconductors**

### **Customer notification**

This data sheet was changed to reflect the new company name NXP Semiconductors. No changes were made to the content, except for the legal definitions and disclaimers.

### **Contact information**

For additional information please visit: http://www.nxp.com

For sales offices addresses send e-mail to: salesaddresses@nxp.com

© NXP B.V. 2009

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands R76/01/pp11 Date of release: 2003 Nov 24 Document order number: 9397 750 11907

